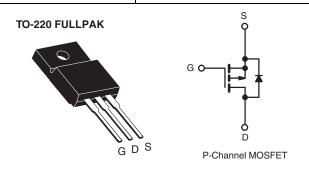


COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	- 25	- 250				
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = - 10 V	1.0				
Q <sub>g</sub> (Max.) (nC)	38					
Q <sub>gs</sub> (nC)	8.0	1				
Q <sub>gd</sub> (nC)	18	18				
Configuration	Sing	Single				



### **FEATURES**

- Advanced Process Technology
- · Dynamic dV/dt Rating
- 150 °C Operating Temperature
- · Fast Switching
- P-Channel
- · Fully Avalanche Rated
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION				
Package	TO-220 FULLPAK			
Lead (Pb)-free	IRFI9634GPbF			
Lead (FD)-liee	SiHFl9634G-E3			
SnPb	IRFI9634G			
31170	SiHFI9634G			

ABSOLUTE MAXIMUM RATINGS T <sub>C</sub> = 25 °C, unless otherwise noted						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	- 250	V	
Gate-Source Voltage			$V_{GS}$	± 20		
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C	1-	- 4.1		
	VGS at - 10 V	$T_C = 100 ^{\circ}C$	I <sub>D</sub>	- 2.6	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 16	1	
Linear Derating Factor				0.28	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	520	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	- 4.1	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.5	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	35	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 1	10 s		300 <sup>d</sup>	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting  $T_J$  = 25 °C, L = 62 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 4.1 A (see fig. 12).
- c.  $I_{SD} \le$  4.1 A,  $dI/dt \le$  640 A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le$  150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# **IRFI9634G, SiHFI9634G**

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.6	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	- 250	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	- 0.27	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V		-	± 100	nA
7 0		V <sub>DS</sub> =	V <sub>DS</sub> = - 250 V, V <sub>GS</sub> = 0 V		-	- 25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 200 '	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	- 250	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 2.5 A <sup>b</sup>	-	-	1.0	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	- 50 V, I <sub>D</sub> = - 4.1 A <sup>b</sup>	2.2	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	680	-	
Output Capacitance	C <sub>oss</sub>		V <sub>DS</sub> = - 25 V,		170	-	1 _
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	40	-	pF
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg		I <sub>D</sub> = - 4.1 A, V <sub>DS</sub> = - 200 V, see fig. 6 and 13 <sup>b</sup>	-	-	38	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	-	8.0	
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	18	
Turn-On Delay Time	t <sub>d(on)</sub>				12	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 130 V, $I_{D}$ = - 4.1 A, $R_{G}$ = 12 $\Omega$ , $R_{D}$ = 31 $\Omega$ , see fig. 10 <sup>b</sup>		-	23	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	34	-	
Fall Time	t <sub>f</sub>			-	21	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 4.1	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 16	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = -4.1  \text{A},  V_{GS} = 0  \text{V}^b$		-	-	- 6.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25  {}^{\circ}\text{C}$ , $I_F = -4.1  \text{A}$ , $dI/dt = -100  \text{A}/\mu \text{s}^b$		-	190	290	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.5	2.2	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	on is don	ninated by	/ L <sub>S</sub> and I	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

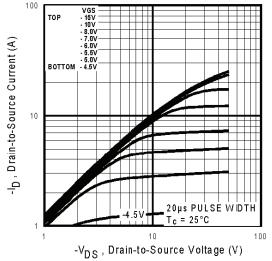


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

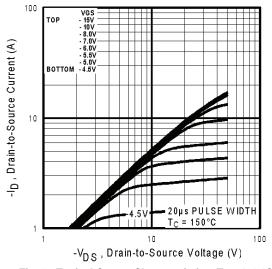


Fig. 2 - Typical Output Characteristics, T  $_{\text{C}}\text{=}$  150  $^{\circ}\text{C}$ 

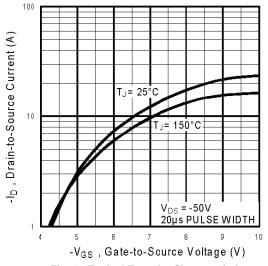


Fig. 3 - Typical Transfer Characteristics

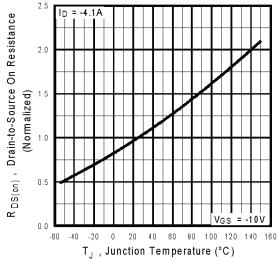


Fig. 4 - Normalized On-Resistance vs. Temperature



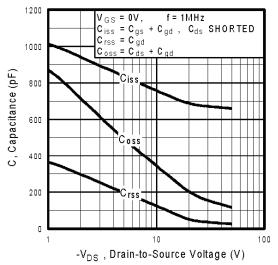


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

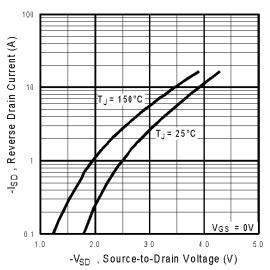


Fig. 7 - Typical Source-Drain Diode Forward Voltage

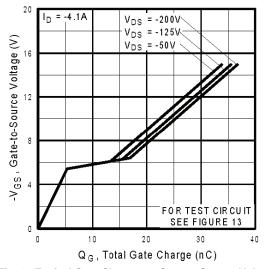


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

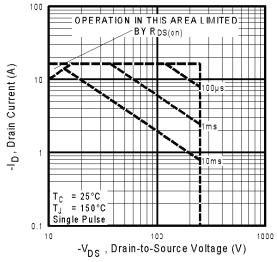


Fig. 8 - Maximum Safe Operating Area

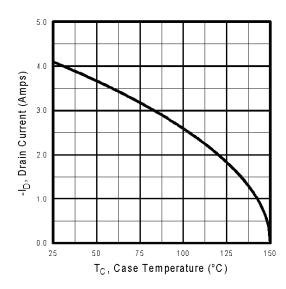


Fig. 9 - Maximum Drain Current vs. Case Temperature

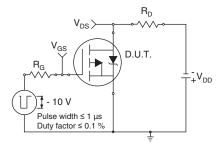


Fig. 10a - Switching Time Test Circuit

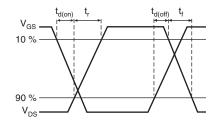


Fig. 10b - Switching Time Waveforms

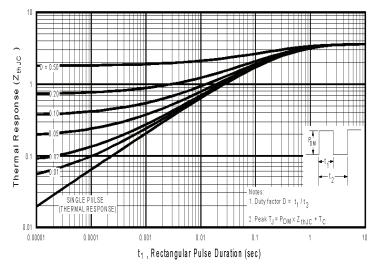
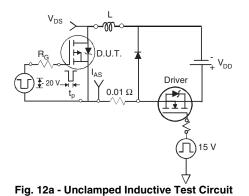


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



I<sub>AS</sub> — V<sub>DS</sub>

Fig. 12b - Unclamped Inductive Waveforms



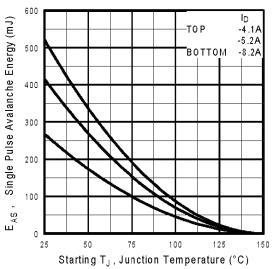


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

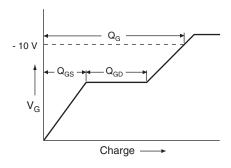


Fig. 13a - Basic Gate Charge Waveform

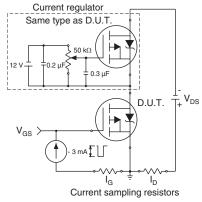
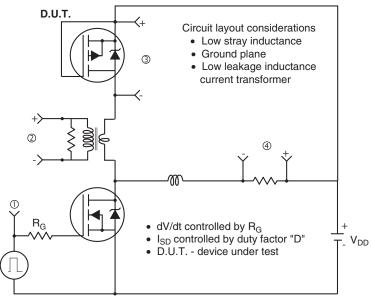


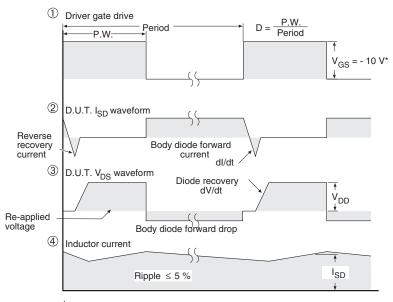
Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



\*  $V_{GS} = -5 \text{ V}$  for logic level and -3 V drive devices

Fig. 14 - For P-Channel

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Document Number: 91168 S09-0062-Rev. A, 02-Feb-09



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